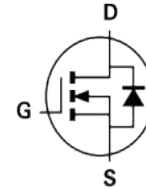


N-Channel Enhancement Mode Power MOSFET

MAIN CHARACTERISTICS

| | |
|---------------------------------------|---------------|
| I_D | 8A |
| V_{DSS} | 500V |
| $R_{DS(on)-typ}$ (@ $V_{GS}=10V$) | 0.68 Ω |



FEATURES

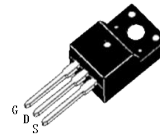
- Fast Switching
- Low ON Resistance
- Low Gate Charge
- 100% Single Pulse avalanche energy Test

APPLICATIONS

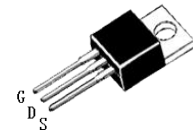
- Power switch circuit of adaptor and charger.

MECHANICAL DATA

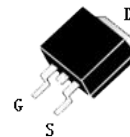
- Case: Molded plastic
- Mounting Position: Any
- Molded Plastic: UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106



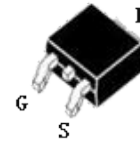
TO-220F



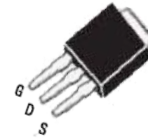
TO-220



TO-263



TO-252



TO-251

Product specification classification

| Part Number | Package | Mark | Pack |
|-------------|---------|---------|------|
| FTK8N50P | TO-220 | FTK8N50 | Tube |
| FTK8N50F | TO-220F | FTK8N50 | Tube |
| FTK8N50DD | TO-263 | FTK8N50 | Tape |
| FTK8N50I | TO-251 | FTK8N50 | Tube |
| FTK8N50D | TO-252 | FTK8N50 | Tube |



N-Channel Enhancement Mode Power MOSFET

Maximum Ratings at Tc=25°C unless otherwise specified

| Characteristics | Symbol | Value | | | Unit |
|---|-----------------|-------------|------|---------|------|
| | | 220/263 | 220F | 251/252 | |
| Drain-Source Voltage | V_{DS} | 500 | | | V |
| Gate-Source Voltage | V_{GS} | ±30 | | | V |
| Continue Drain Current | I_D | 8 | | | A |
| Pulsed Drain Current (Note1) | I_{DM} | 32 | | | A |
| Power Dissipation | P_D | 100 | 35 | 100 | W |
| Single Pulse Avalanche Energy (Note1) | E_{AS} | 440 | | | mJ |
| Operating Temperature Range | T_J | 150 | | | °C |
| Storage Temperature Range | T_{STG} | -55 to +150 | | | °C |
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 1.25 | 3.57 | 1.25 | °C/W |
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}$ | 62.5 | 62.5 | 62.5 | °C/W |

Note1:Pulse test: 300 μs pulse width, 2 % duty cycle

Electrical Characteristics at Tc=25°C unless otherwise specified

| Characteristics | Test Condition | Symbol | Min | Typ | Max | Unit |
|----------------------------------|---|--------------|-----|------|------|------|
| Drain-Source Breakdown Voltage | $V_{GS} = 0 V, I_D = 250 \mu A$ | BV_{DSS} | 500 | - | - | V |
| Drain-Source Leakage Current | $V_{DS} = 500 V, V_{GS} = 0 V$ | I_{DSS} | - | - | 1 | μA |
| Gate Leakage Current | $V_{GS} = \pm 30 V, V_{DS} = 0 V$ | I_{GSS} | - | - | ±100 | nA |
| Gate-Source Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | $V_{GS(th)}$ | 2 | - | 4 | V |
| Drain-Source On-State Resistance | $V_{GS} = 10 V, I_D = 4 A$ | $R_{DS(on)}$ | - | 0.68 | 0.8 | Ω |
| Forward Transconductance | $V_{DS} = 15 V, I_D = 4 A$ | g_{fs} | - | 7 | - | S |
| Input Capacitance | $V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$ | C_{iss} | - | 891 | - | pF |
| Output Capacitance | | C_{oss} | - | 110 | - | pF |
| Reverse Transfer Capacitance | | C_{rss} | - | 7 | - | pF |
| Turn-on Delay Time(Note2) | $I_D = 8 A, V_{DD} = 250V, R_G = 10 \Omega$ | $t_{d(ON)}$ | - | 18 | - | ns |
| Rise Time(Note2) | | t_r | - | 20 | - | ns |
| Turn-Off Delay Time(Note2) | | $t_{d(OFF)}$ | - | 44 | - | ns |
| Fall Time(Note2) | | t_f | - | 15 | - | ns |
| Total Gate Charge(Note2) | $I_D = 8 A, V_{DD} = 400 V, V_{GS} = 10 V$ | Q_G | - | 22 | - | nC |
| Gate to Source Charge(Note2) | | Q_{GS} | - | 5 | - | nC |
| Gate to Drain Charge(Note2) | | Q_{GD} | - | 9 | - | nC |

Source-Drain Diode Characteristics at Ta=25°C unless otherwise specified

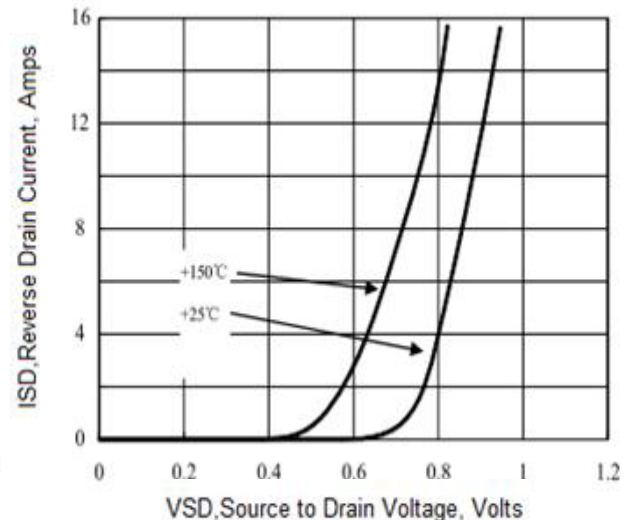
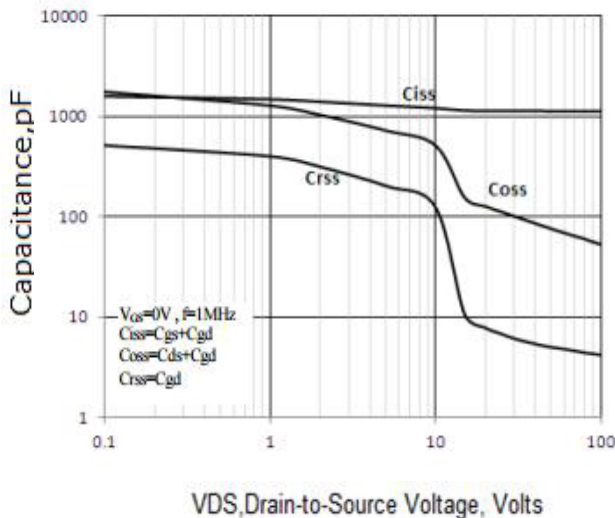
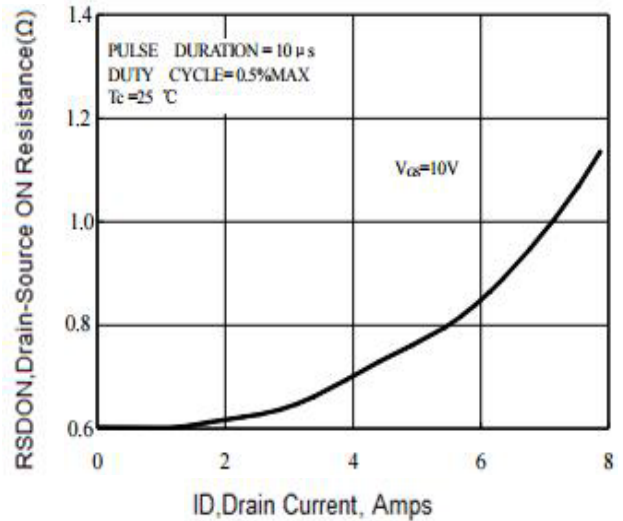
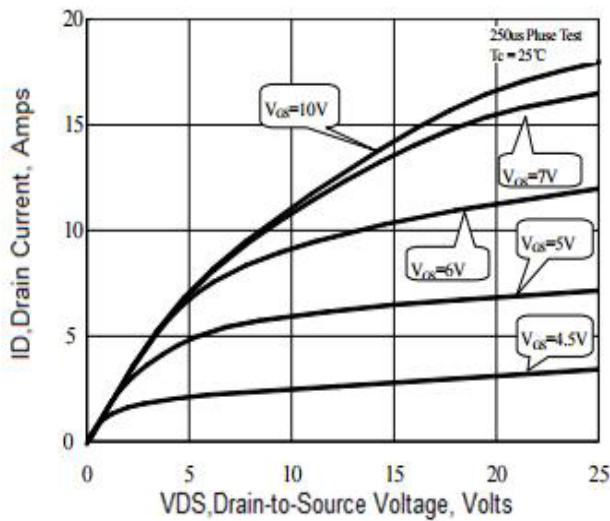
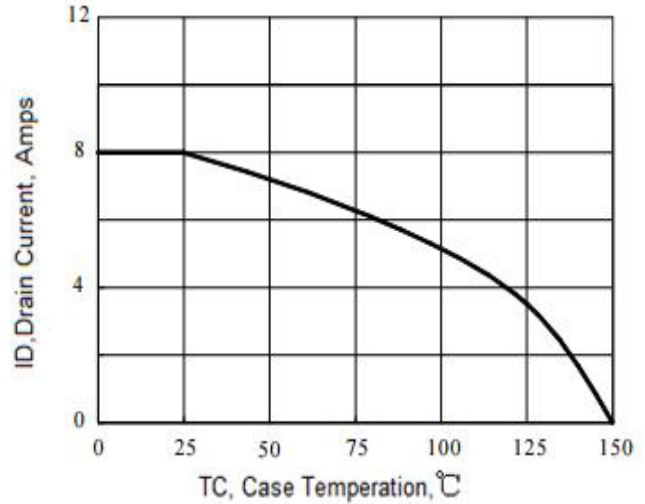
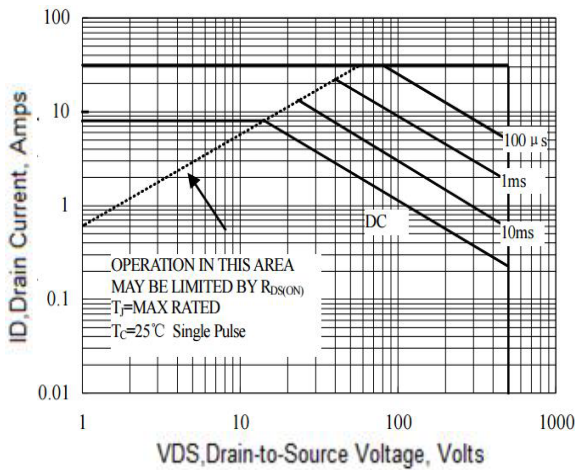
| Characteristics | Test Condition | Symbol | Min. | Typ. | Max. | Unit |
|--|--------------------------|----------|------|------|------|------|
| Maximun Body-Diode Continuous Current | $TC = 25^\circ C$ | I_S | - | - | 8 | A |
| Maximun Body-Diode Pulsed Current(Note2) | | I_{SM} | - | - | 32 | A |
| Drain-Source Diode Forward Voltage | $I_{SD} = 8 A$ | V_{SD} | - | - | 1.4 | V |
| Reverse Recovery Time(Note2) | $IS=8A, Tj = 25^\circ C$ | t_{rr} | - | 340 | - | ns |
| Reverse Recovery Charge(Note2) | $dIF/dt=100A/us, VGS=0V$ | Q_{rr} | - | 1.7 | - | μC |

Note2:Pulse test: 300 μs pulse width, 2 % duty cycle



N-Channel Enhancement Mode Power MOSFET

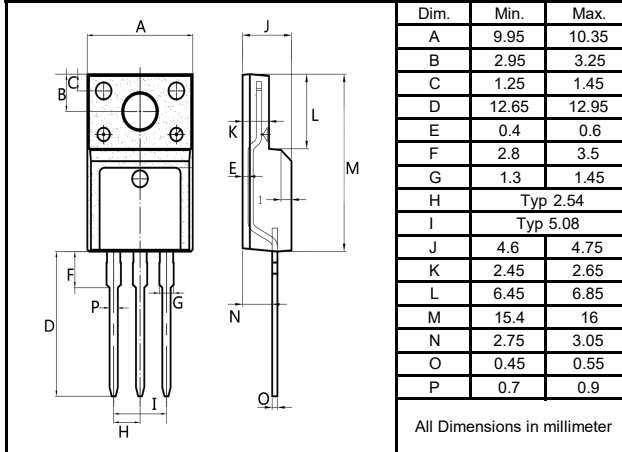
RATINGS AND CHARACTERISTIC CURVES



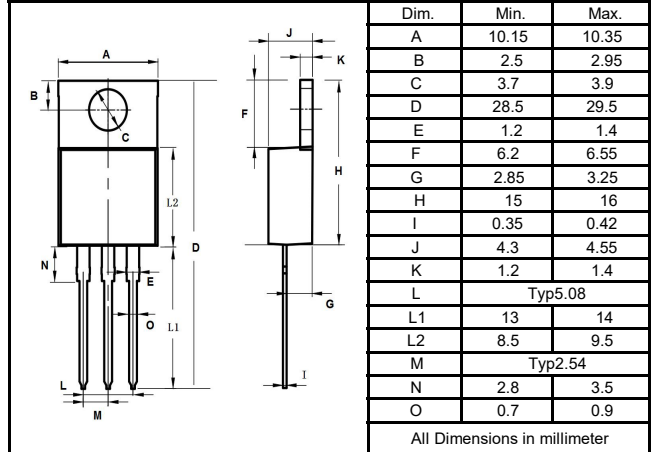
N-Channel Enhancement Mode Power MOSFET

Package Outline Dimensions millimeters

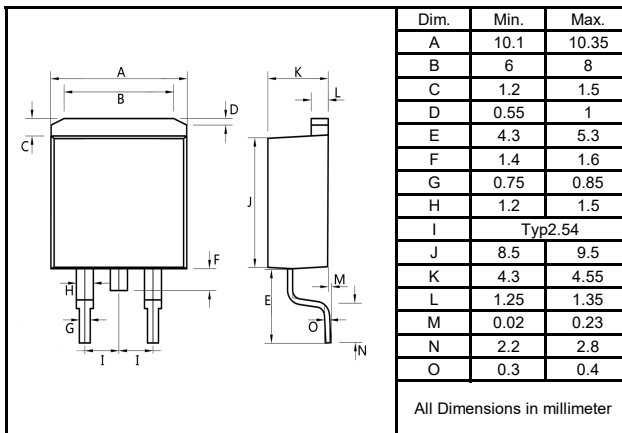
T0-220F



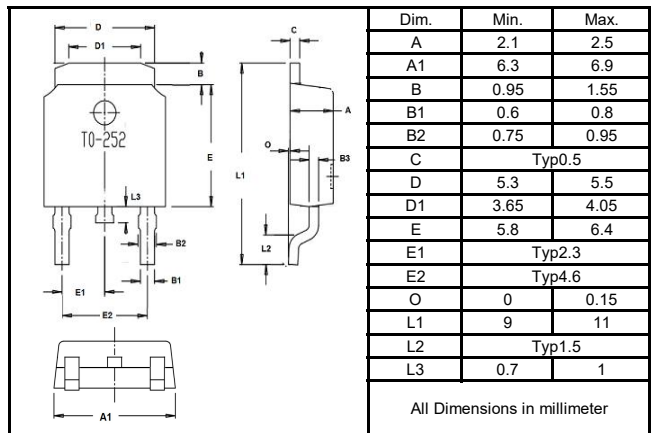
T0-220



T0-263



T0-252



T0-251

